GSE033MB1N6F

ESD Protection Diode

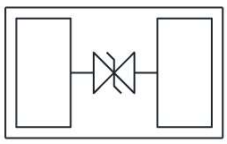
Product Description

It is designed to protect sensitive electronics from damage or latch up due to ESD, lightning, and other voltage induced transient events.

Features

- Bidirectional Device
- Peak Pulse Power : 50W (8/20μs)
- Operating Voltage : 3.3V
- Low Leakage Current: nA Level
- Low Capacitance: 1.0pF Max.
- IEC61000-4-2(ESD) ±30kV (air)
- IEC61000-4-2(ESD) ±30kV (contact)
- IEC61000-4-5(Lighting) 10A (8/20μs)
- RoHS Compliant

Package & Device Schematic



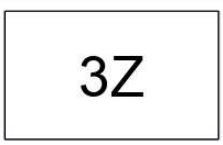
DFN0603-2

Applications

- High Speed Line: USB1.0/2.0, VGA, DVI, SDI
- Serial and Parallel Ports
- Notebooks, Desktops, Servers
- Cellular handsets and accessories
- Portable instrumentation
- Peripherals

Ordering Information & Marking Code

Part Number	Package	Quantity	Marking Code
GSE033MB1N6F	DFN0603-2	10KPCS	3Z



3Z = Product Code

Absolute Maximum Ratings

(T_A=25ºC unless otherwise specified)

Symbol	Parameter	Typical	Unit
P_{PP}	Peak Pulse Power (t_P=8/20μs)	50	W
I_{PP}	Peak Pulse Current (t_P=8/20μs)	10	A
V_{ESD}	ESD Per IEC61000-4-2 (Air)	±30	KV
	ESD Per IEC61000-4-2 (Contact)	±30	KV
T_J	Operating Junction Temperature Range	-55 to +125	ºC
T_{STG}	Storage Temperature Range	-55 to +150	ºC

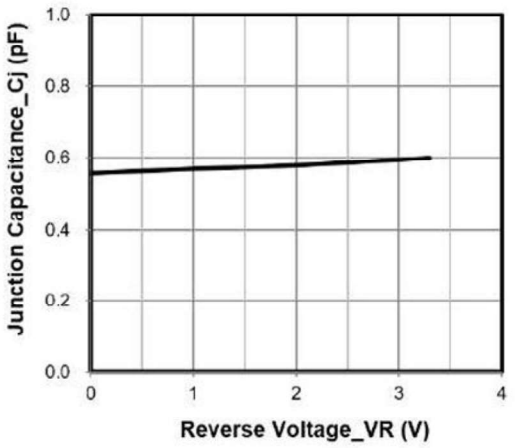
Note : Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

Electrical Characteristics

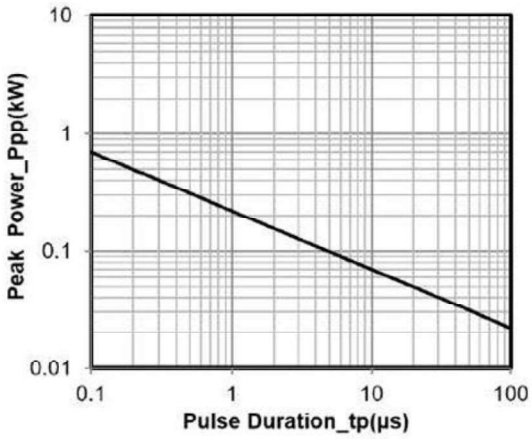
(T_A=25ºC unless otherwise specified)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{RWM}	Reverse Working Voltage	-			3.3	V
V_{BR}	Reverse Breakdown Voltage	I_R=2μA	3.5			V
I_R	Reverse Leakage Current	V_{RWM}=3.3V			0.2	μA
V_C	Clamping Voltage	I_{PP}=1A (8/20μs)			3	V
		I_{PP}=10A (8/20μs)			5	V
C_J	Junction Capacitance	V_R=0V, f=1MHz			1.0	pF

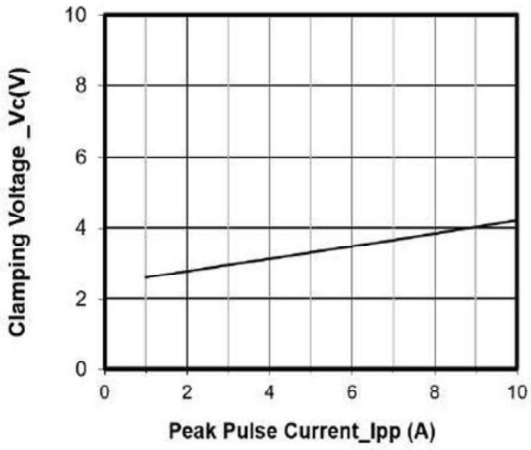
Typical Characteristics (TA=25℃ unless otherwise specified)



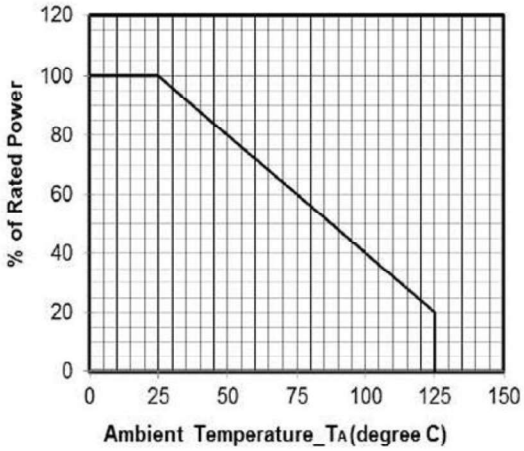
Junction Capacitance vs. Reverse Voltage



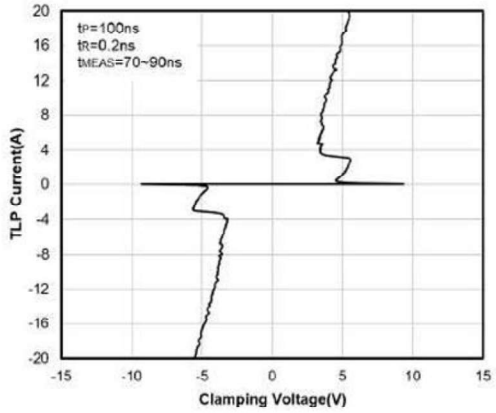
Peak Pulse Power vs. Pulse Time



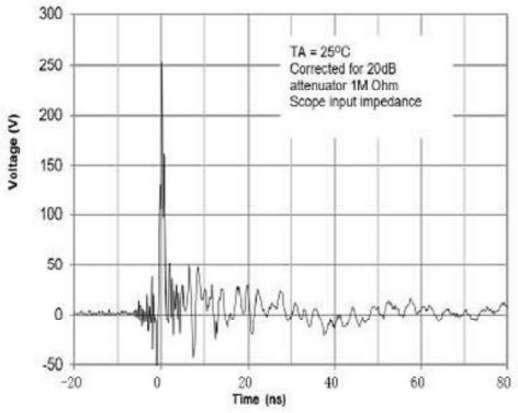
Clamping Voltage vs. Peak Pulse Current



Power Derating Curve



TLP Curve

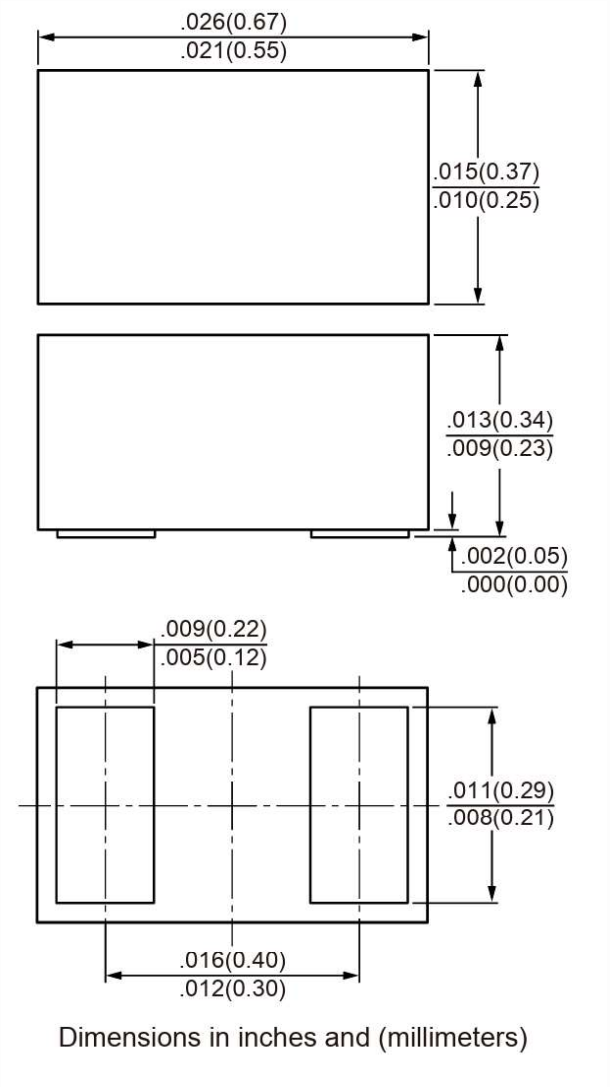


ESD Clamping Voltage

8 kV Contact per IEC61000-4-2

Package Dimension

DFN0603-2



Dimensions in inches and (millimeters)

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